

CoolMOS™ CFD7A 650V CoolMOS™ CFD7A SJ Power Device

650V CoolMOS™ CFD7A is Infineon's latest generation of market leading automotive qualified high voltage CoolMOS™ MOSFETs. In addition to the well-known attributes of high quality and reliability required by the automotive industry, the new CoolMOS™ CFD7A series provides for an integrated fast body diode and can be used for PFC and resonant switching topologies like the ZVS phase-shift full-bridge and LLC.

PG-T0247-4

Features

- Latest 650V automotive qualified technology with integrated fast body diode on the market featuring ultra low Q_r
- Lowest FOM $R_{DS(on)}{}^{*}Q_{g}$ and $R_{DS(on)}{}^{*}E_{oss}$ • 100% avalanche tested
- Best-in-class R_{DS(on)} in SMD and THD packages

Benefits

- Optimized for higher battery voltages up to 475 V thanks to further improved robustness
- Lower switching losses enabling higher switching frequencies
- High quality and reliability
- Increased efficiency in light load and full load conditions

Potential applications

Suitable for PFC and DC-DC stages for:

- Unidirectional and bidirectional DC-DC converters,
- On-Board battery Chargers



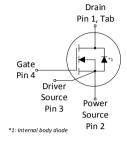
Qualified according to AEC Q101

Please note: For production part approval process (PPAP) release we propose to share application related information during an early design phase to avoid delays in PPAP release. Please contact Infineon sales office. The source and sense source pins are not exchangeable. Their exchange might lead to malfunction. For paralleling 4pin MOSFET devices the placement of the gate resistor is generally recommended to be on the Driver Source instead of the Gate.

Table 1 **Kev Performance Parameters**

Parameter	Value	Unit
V_{DS}	650	V
R _{DS(on),max}	35	mΩ
$Q_{g,typ}$	145	nC
I _{D,pulse}	304	А
E _{oss} @ 400V	18.4	μЈ
Body diode di _F /dt	1300	A/μs

Type/Ordering Code	Package	Marking	Related Links
IPZA65R035CFD7A	PG-TO247-4	65A035F7	see Appendix A





Public

650V CoolMOS™ CFD7A SJ Power Device IPZA65R035CFD7A



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1 Maximum ratings at $T_j = 25^{\circ}$ C, unless otherwise specified

Maximum ratings Table 2

Davamakav	Symbol	Values		Linit	Nata/Task Canditian	
Parameter	Min. Typ. Max.		Unit	Note/ Test Condition		
Continuous drain current 1)	I _D	-	-	63	А	T _c =25°C
Continuous drain current	I _D	-	-	40	Α	T _C =100°C
Pulsed drain current ²⁾	I _{D,pulse}	-	-	304	А	T _c =25°C
Avalanche energy, single pulse	E _{AS}	-	-	358	mJ	I _D =7.3A; V _{DD} =50V; see table 10
Avalanche current, single pulse	I _{AS}	-	-	7.3	Α	-
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	V _{DS} =0400V
Gate source voltage (static)	$V_{\rm GS}$	-20	-	20	V	static;
Gate source voltage (dynamic)	$V_{\rm GS,pulse}$	-30	-	30	V	$f_{\text{repetition}} \le 100 \text{kHz}, t_{\text{pulse}} \le 2 \text{ns}$
Power dissipation	P _{tot}	-	-	305	W	<i>T</i> _C =25°C
Storage temperature	$T_{\rm stg}$	-55	-	150	°C	-
Operating junction temperature	T _j	-40	-	150	°C	-
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws
Continuous diode forward current	Is	-	-	63	Α	T _C =25°C
Diode pulse current ²⁾	I _{S,pulse}	-	-	304	А	T _C =25°C
Reverse diode dv/dt ³⁾	dv/dt	-	-	70	V/ns	V _{DS} =0400V, I _{SD} ≤35.8A, T _j =25°C see table 8
Maximum diode commutation speed	di _F /dt	-	-	1300	A/μs	V _{DS} =0400V, I _{SD} ≤35.8A, T _j =25°C see table 8

 $^{^{1)}}$ Limited by $T_{j,max}$

²⁾ Pulse width t_p limited by $T_{j,max}$

³⁾ Identical low side and high side switch with identical R_G



2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note/ Test Condition	
raiametei	Syllibot	Min.	Тур.	Мах.	Offic	Note/ Test Condition	
Thermal resistance, junction - case	R_{thJC}	-	-	0.41	°C/W	-	
Soldering temperature, wavesoldering only allowed at leads	$T_{\rm sold}$	-	_	260	°C	1.6mm (0.063 in.) from case for 10s	



3 Electrical characteristics

at T_i=25°C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition	
raiailletei	Syllibol	Min.	Тур.	Max.	Offic	Note/ Test Condition	
Drain-source breakdown voltage ⁴⁾	$V_{(BR)DSS}$	650	-	-	V	$V_{\rm GS}$ =0V, $I_{\rm D}$ =1mA	
Gate threshold voltage ⁵⁾	$V_{(GS)th}$	3.5	4	4.5	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 1.79 \rm mA$	
Zero gate voltage drain current	I _{DSS}	-	- 160	1	μΑ	$V_{\rm DS}$ =650V, $V_{\rm GS}$ =0V, $T_{\rm j}$ =25°C $V_{\rm DS}$ =650V, $V_{\rm GS}$ =0V, $T_{\rm j}$ =150°C	
Gate-source leakage current	I_{GSS}	-	-	0.1	μΑ	V _{GS} =20V, V _{DS} =0V	
Drain-source on-state resistance	R _{DS(on)}	-	0.029 0.064	0.035 -	Ω	$V_{\rm GS}$ =10V, $I_{\rm D}$ =35.8A, $T_{\rm j}$ =25°C $V_{\rm GS}$ =10V, $I_{\rm D}$ =35.8A, $T_{\rm j}$ =150°C	
Gate resistance	R_{G}	-	3.8	-	Ω	<i>f</i> =250kHz, open drain	

⁴⁾ For applications with applied blocking voltage > 475 V of the specified blocking voltage, it is required that the customer evaluates the impact of cosmic radiation effect in early design phase and contacts the Infineon sales office for the necessary technical support by Infineon.

Table 5 Dynamic characteristics

External parasitic elements (PCB layout) influence switching behavior significantly. Stray inductances and coupling capacitances must be minimized. For layout recommendations please use provided application notes or contact Infineon sales office.

Darameter	Symbol		Values	5	Unit	Note / Took Condition	
Parameter	meter Symbol Min. Typ. Max.		Мах.	Offic	Note/ Test Condition		
Input capacitance	C _{iss}	-	7149	-	pF	V _{GS} =0V, V _{DS} =400V, <i>f</i> =250kHz	
Output capacitance	Coss	-	95	-	pF	V _{GS} =0V, V _{DS} =400V, <i>f</i> =250kHz	
Effective output capacitance, energy related ⁶⁾	$C_{\rm o(er)}$	-	230	-	pF	V _{GS} =0V, V _{DS} =0400V	
Effective output capacitance, time related ⁷⁾	$C_{\rm o(tr)}$	-	2430	-	pF	$I_{\rm D}$ =constant, $V_{\rm GS}$ =0V, $V_{\rm DS}$ =0400V	
Turn-on delay time	$t_{\sf d(on)}$	-	30	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8Ω; see table 9	
Rise time	$t_{\rm r}$	-	9.2	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8Ω; see table 9	
Turn-off delay time	$t_{ m d(off)}$	-	131	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8Ω; see table 9	
Fall time	t_{f}	-	2.7	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8Ω; see table 9	

⁵⁾ We do not recommend using the CoolMOS mentioned in this datasheet to operate in "linear mode". For assessment of potential "linear mode", please contact Infineon sales office.



 $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V

Table 6 Gate charge characteristics

Parameter	Symbol	Values			Unit	Note/ Test Condition
raiametei	Symbol	Min.	Тур.	Мах.	Oilit	Note, rest condition
Gate to source charge	$Q_{ m gs}$	-	41	-	nC	$V_{\rm DD}$ =400V, $I_{\rm D}$ =35.8A, $V_{\rm GS}$ =0 to 10V
Gate to drain charge	$Q_{ m gd}$	-	44	-	nC	$V_{\rm DD}$ =400V, $I_{\rm D}$ =35.8A, $V_{\rm GS}$ =0 to 10V
Gate charge total	$Q_{ m g}$	-	145	-	nC	$V_{\rm DD}$ =400V, $I_{\rm D}$ =35.8A, $V_{\rm GS}$ =0 to 10V
Gate plateau voltage	$V_{ m plateau}$	-	5.7	-	V	$V_{\rm DD}$ =400V, $I_{\rm D}$ =35.8A, $V_{\rm GS}$ =0 to 10V

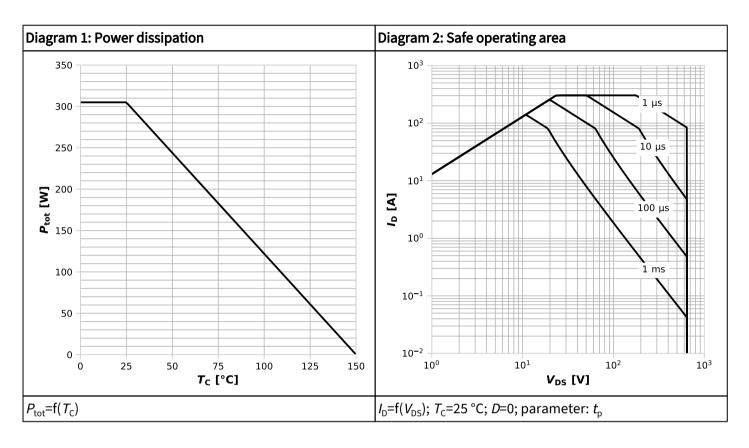
Table 7 Reverse diode characteristics

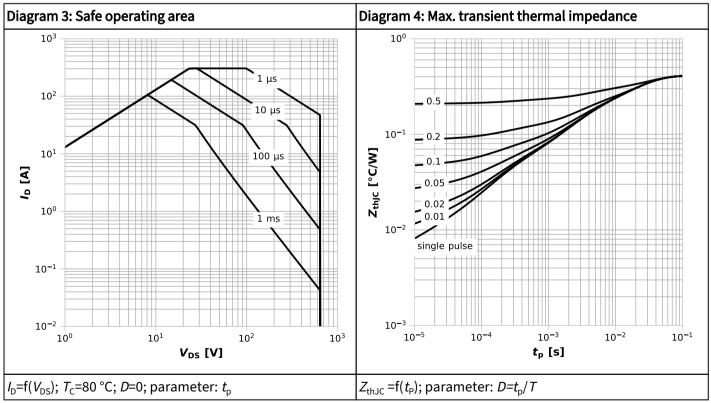
Parameter	Symbol	Values			Unit	Note/ Test Condition	
- arameter	Syllibot	Min.	Тур.	Мах.	Oilit	Note, rest condition	
Diode forward voltage	V_{SD}	-	1.1	-	V	$V_{\rm GS}$ =0V, $I_{\rm F}$ =35.8A, $T_{\rm j}$ =25°C	
Reverse recovery time	t _{rr}	-	208	-	ns	$V_{\rm R}$ =400V, $I_{\rm F}$ =35.8A, d $i_{\rm F}$ /d t =100A/ μ s; see table 8	
Reverse recovery charge	$Q_{\rm rr}$	-	1.60	-	μC	$V_{\rm R}$ =400V, $I_{\rm F}$ =35.8A, d $i_{\rm F}$ /d t =100A/ μ s; see table 8	
Peak reverse recovery current	I _{rrm}	-	13.1	-	Α	$V_{\rm R}$ =400V, $I_{\rm F}$ =35.8A, d $i_{\rm F}$ /d t =100A/ μ s; see table 8	

⁷⁾ $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400V

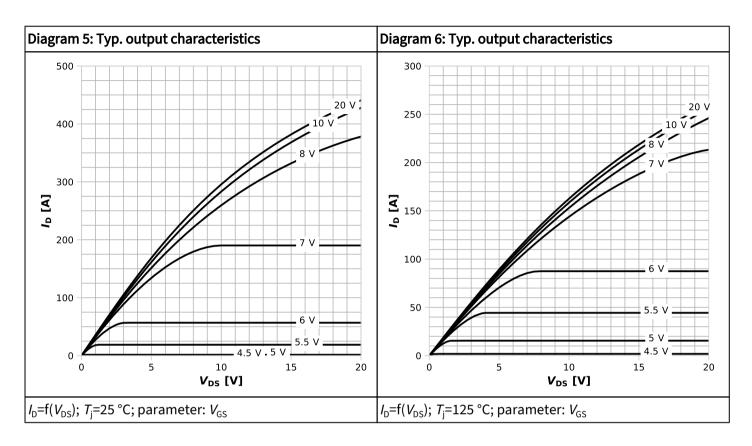


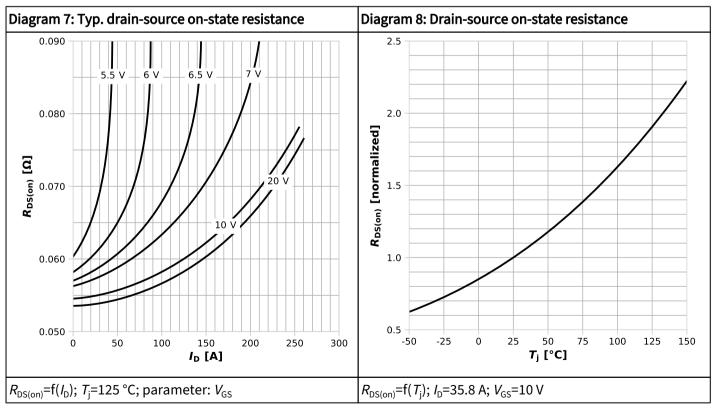
4 Electrical characteristics diagrams



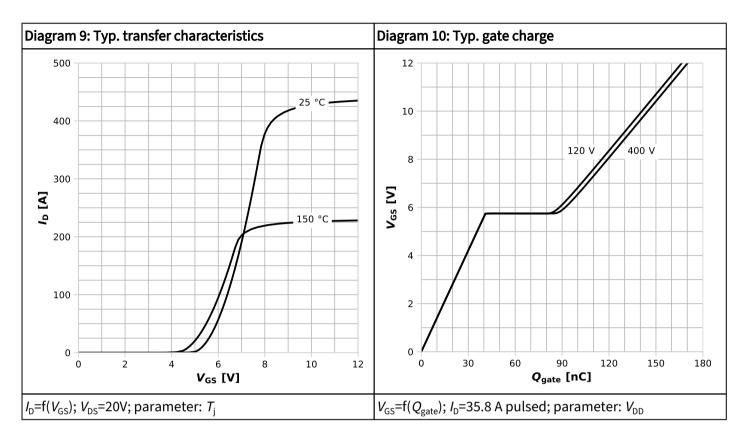


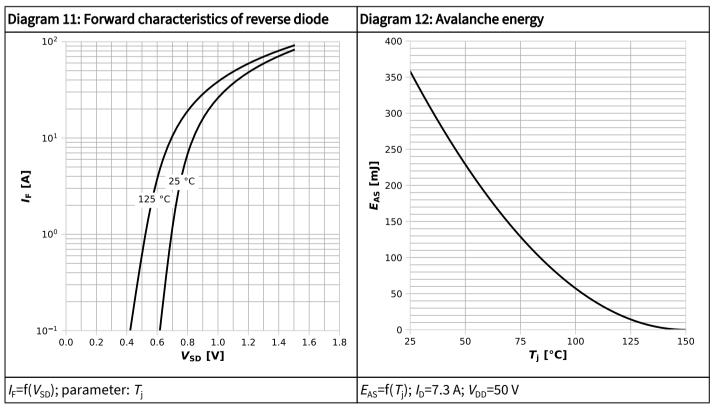




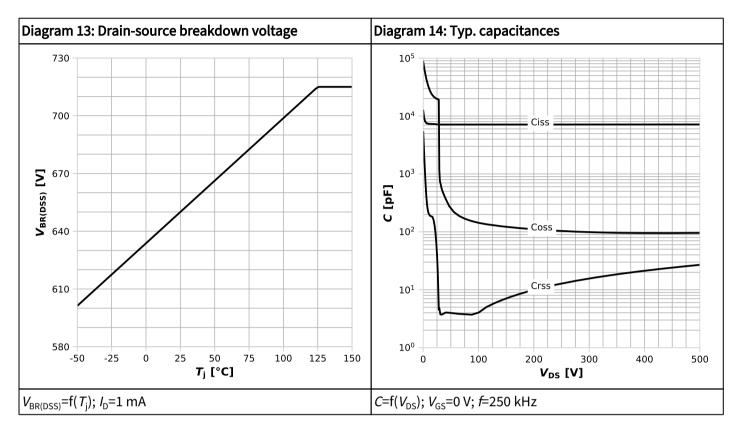


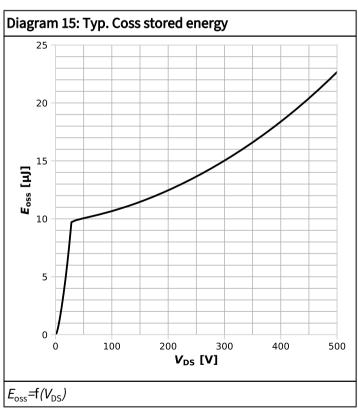














5 Test Circuits

Table 8 Diode characteristics

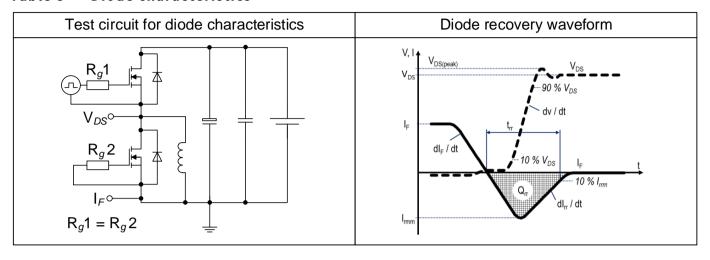


Table 9 Switching times (ss)

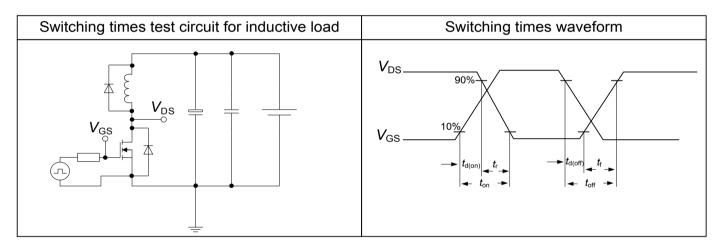
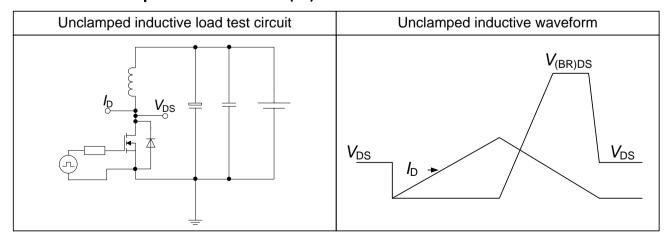
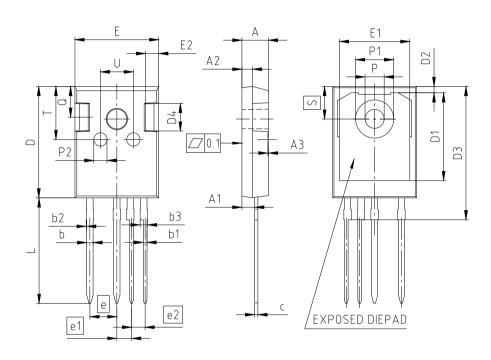


Table 10 Unclamped inductive load (ss)





6 Package Outlines



NOTES:
DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURRS

PACKAGE - GROUP NUMBER:	PG-TO2	47-4-U02			
DIMENSIONS	MILLIMETERS		DIMENSIONS	MILLIN	ETERS
DIMENSIONS	MIN.	MAX.	DIMENSIONS	MIN.	MAX.
Α	4.90	5.10	E	15.70	15.90
A1	2.31	2.51	E1	13.10	13.50
A2	1.90	2.10	E2	2.40	2.60
A3	0.05	0.25	е	5.	08
b	1.10	1.30	e1	2.79	
b1	0.65	0.79	e2	2.54	
b2		0.20	N	4	1
b3	1.34	1.44	L	19.80	20.10
С	0.58	0.66	øΡ	3.50	3.70
D	20.90	21.10	øP1	7.00	7.40
D1	16.25	16.85	øP2	2.40	2.60
D2	1.05	1.35	Q	5.60	6.00
D3	24.97	25.27	S	6.	15
D4	4.90	5.10	Т	9.80	10.20
			U	6.00	6.40

Figure 1 Outline PG-TO247-4, dimensions in mm



7 Appendix A

Table 11 Related Links

- IFX CoolMOS CFD7A Webpage
- IFX CoolMOS CFD7A application note
- IFX CoolMOS CFD7A simulation model
- IFX Design tools



Revision History

IPZA65R035CFD7A

Revision 2024-04-29, Rev. 2.0

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Prev	צווחוי	Rev	ision

Revision	Date	Subjects (major changes since last revision)
2.0	2024-04-29	Release of final

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